

# 74HC2G126; 74HCT2G126

Dual buffer/line driver; 3-state

Rev. 02 — 15 December 2005

Product data sheet

## 1. General description

The 74HC2G126; 74HCT2G126 is a high-speed Si-gate CMOS device.

The 74HC2G126; 74HCT2G126 provides two non-inverting buffer/line drivers with 3-state output. The 3-state output is controlled by the output enable input pin (OE). A LOW at pin OE causes the output to assume a high-impedance OFF-state.

The bus driver output currents are equal compared to the 74HC126 and 74HCT126.

## 2. Features

- Wide operating voltage from 2.0 V to 6.0 V
- Symmetrical output impedance
- High noise immunity
- Low power dissipation
- Balanced propagation delays
- ESD protection:
  - ◆ HBM EIA/JESD22-A114-C exceeds 2000 V
  - ◆ MM EIA/JESD22-A115-A exceeds 200 V
- Very small 8 pins package
- Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$  and  $-40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$

## 3. Quick reference data

**Table 1: Quick reference data**

$GND = 0\text{ V}$ ;  $T_{amb} = 25\text{ }^{\circ}\text{C}$ ;  $t_r = t_f = \leq 6\text{ ns}$ .

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>74HC2G126</b>						
$t_{PHL}$ , $t_{PLH}$	propagation delay nA to nY	$V_{CC} = 5\text{ V}$ ; $C_L = 15\text{ pF}$	-	10	-	ns
$C_i$	input capacitance		-	1	-	pF
$C_o$	output capacitance		-	1.5	-	pF
$C_{PD}$	power dissipation capacitance	per buffer; $V_I = GND$ to $V_{CC}$ <a href="#">[1]</a>				
		output enabled	-	11	-	pF
		output disabled	-	1	-	pF
<b>74HCT2G126</b>						
$t_{PHL}$ , $t_{PLH}$	propagation delay nA to nY	$V_{CC} = 5\text{ V}$ ; $C_L = 15\text{ pF}$	-	12	-	ns

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**Table 1: Quick reference data ...continued**

$GND = 0\text{ V}$ ;  $T_{amb} = 25\text{ }^\circ\text{C}$ ;  $t_r = t_f = \leq 6\text{ ns}$ .

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$C_i$	input capacitance		-	1	-	pF
$C_o$	output capacitance		-	1.5	-	pF
$C_{PD}$	power dissipation capacitance	per buffer; $V_I = GND$ to $(V_{CC} - 1.5\text{ V})$	[1]			
		output enabled	-	11	-	pF
		output disabled	-	1	-	pF

[1]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

$f_i$  = input frequency in MHz;

$f_o$  = output frequency in MHz;

$C_L$  = output load capacitance in pF;

$V_{CC}$  = supply voltage in V;

$N$  = number of inputs switching;

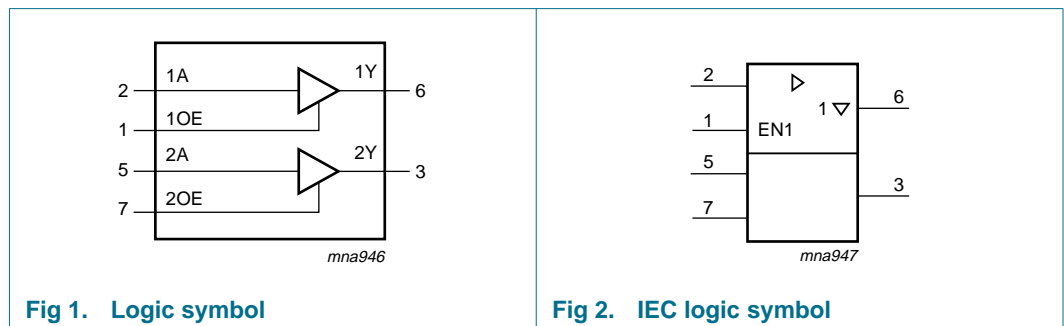
$\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

## 4. Ordering information

**Table 2: Ordering information**

Type number	Package			Version
	Temperature range	Name	Description	
<b>74HC2G126</b>				
74HC2G126DP	-40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	SOT505-2
74HC2G126DC	-40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1
<b>74HCT2G126</b>				
74HCT2G126DP	-40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	SOT505-2
74HCT2G126DC	-40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1

## 5. Functional diagram



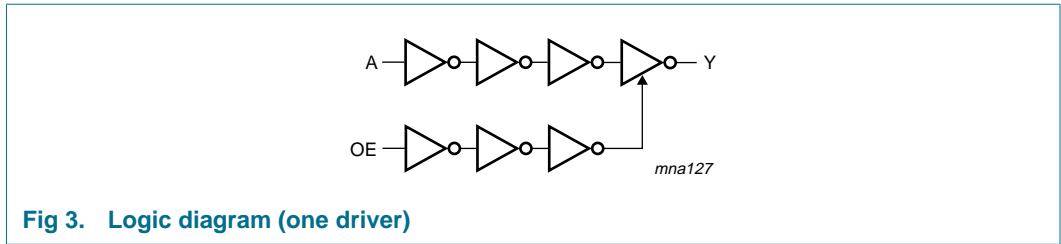


Fig 3. Logic diagram (one driver)

## 6. Pinning information

### 6.1 Pinning

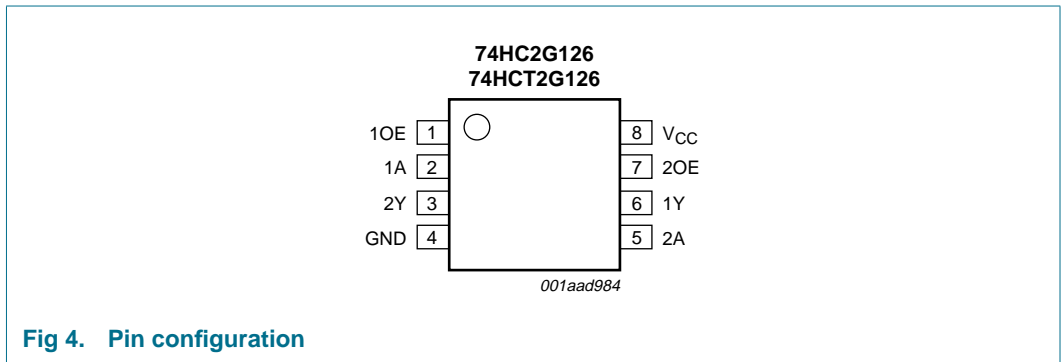


Fig 4. Pin configuration

### 6.2 Pin description

Table 3: Pin description

Symbol	Pin	Description
1OE	1	1 output enable input
1A	2	1 data input
2Y	3	2 data output
GND	4	ground (0 V)
2A	5	2 data input
1Y	6	1 data output
2OE	7	2 output enable input
V <sub>CC</sub>	8	supply voltage

## 7. Functional description

### 7.1 Function table

Table 4: Function table [1]

Control	Input	Output
nOE	nA	nY
H	L	L
	H	H
L	X	Z

[1] H = HIGH voltage level;  
L = LOW voltage level;  
X = don't care;  
Z = high-impedance OFF-state.

## 8. Limiting values

Table 5: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+7.0	V
$I_{IK}$	input clamping current	$V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$	-	$\pm 20$	mA
$I_{OK}$	output clamping current	$V_O < -0.5\text{ V}$ or $V_O > V_{CC} + 0.5\text{ V}$	-	$\pm 20$	mA
$I_O$	output current	$V_O = -0.5\text{ V}$ to $(V_{CC} + 0.5\text{ V})$	-	$\pm 35$	mA
$I_{CC}$	quiescent supply current		-	70	mA
$I_{GND}$	ground current		-	-70	mA
$T_{stg}$	storage temperature		-65	+150	°C
$P_{tot}$	total power dissipation		[1]	300	mW

[1] Above 110 °C the value of  $P_{tot}$  derates linearly with 8 mW/K.

## 9. Recommended operating conditions

Table 6: Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>74HC2G126</b>						
$V_{CC}$	supply voltage		2.0	5.0	6.0	V
$V_I$	input voltage		0	-	$V_{CC}$	V
$V_O$	output voltage		0	-	$V_{CC}$	V
$T_{amb}$	ambient temperature		-40	+25	+125	°C
$t_r, t_f$	input rise and fall times	$V_{CC} = 2.0\text{ V}$	-	-	1 000	ns
		$V_{CC} = 4.5\text{ V}$	-	6.0	500	ns
		$V_{CC} = 6.0\text{ V}$	-	-	400	ns

Table 6: Recommended operating conditions ...continued

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>74HCT2G126</b>						
$V_{CC}$	supply voltage		4.5	5.0	5.5	V
$V_I$	input voltage		0	-	$V_{CC}$	V
$V_O$	output voltage		0	-	$V_{CC}$	V
$T_{amb}$	ambient temperature		-40	+25	+125	°C
$t_r, t_f$	input rise and fall times	$V_{CC} = 4.5\text{ V}$	-	6.0	500	ns

## 10. Static characteristics

Table 7: Static characteristics 74HC2G126

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$T_{amb} = -40\text{ °C to }+85\text{ °C}$ [1]						
$V_{IH}$	HIGH-state input voltage	$V_{CC} = 2.0\text{ V}$	1.5	1.2	-	V
		$V_{CC} = 4.5\text{ V}$	3.15	2.4	-	V
		$V_{CC} = 6.0\text{ V}$	4.2	3.2	-	V
$V_{IL}$	LOW-state input voltage	$V_{CC} = 2.0\text{ V}$	-	0.8	0.5	V
		$V_{CC} = 4.5\text{ V}$	-	2.1	1.35	V
		$V_{CC} = 6.0\text{ V}$	-	2.8	1.8	V
$V_{OH}$	HIGH-state output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = -20\text{ }\mu\text{A}; V_{CC} = 2.0\text{ V}$	1.9	2.0	-	V
		$I_O = -20\text{ }\mu\text{A}; V_{CC} = 4.5\text{ V}$	4.4	4.5	-	V
		$I_O = -20\text{ }\mu\text{A}; V_{CC} = 6.0\text{ V}$	5.9	6.0	-	V
		$I_O = -6.0\text{ mA}; V_{CC} = 4.5\text{ V}$	3.84	4.32	-	V
$V_{OL}$	LOW-state output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = 20\text{ }\mu\text{A}; V_{CC} = 2.0\text{ V}$	-	0	0.1	V
		$I_O = 20\text{ }\mu\text{A}; V_{CC} = 4.5\text{ V}$	-	0	0.1	V
		$I_O = 20\text{ }\mu\text{A}; V_{CC} = 6.0\text{ V}$	-	0	0.1	V
		$I_O = 6.0\text{ mA}; V_{CC} = 4.5\text{ V}$	-	0.15	0.33	V
		$I_O = 7.8\text{ mA}; V_{CC} = 6.0\text{ V}$	-	0.16	0.33	V
$I_{LI}$	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0\text{ V}$			$\pm 1.0$	$\mu\text{A}$
$I_{OZ}$	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}; V_O = V_{CC}$ or GND; $V_{CC} = 6.0\text{ V}$			$\pm 5.0$	$\mu\text{A}$
$I_{CC}$	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0\text{ A}; V_{CC} = 6.0\text{ V}$			10.0	$\mu\text{A}$
$C_i$	input capacitance		-	1	-	pF
$C_o$	output capacitance		-	1.5	-	pF

**Table 7: Static characteristics 74HC2G126 ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>T<sub>amb</sub> = -40 °C to +125 °C</b>						
V <sub>IH</sub>	HIGH-state input voltage	V <sub>CC</sub> = 2.0 V	1.5	-	-	V
		V <sub>CC</sub> = 4.5 V	3.15	-	-	V
		V <sub>CC</sub> = 6.0 V	4.2	-	-	V
V <sub>IL</sub>	LOW-state input voltage	V <sub>CC</sub> = 2.0 V	-	-	0.5	V
		V <sub>CC</sub> = 4.5 V	-	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	-	1.8	V
V <sub>OH</sub>	HIGH-state output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	1.9	-	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	4.4	-	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	5.9	-	-	V
		I <sub>O</sub> = -6.0 mA; V <sub>CC</sub> = 4.5 V	3.7	-	-	V
V <sub>OL</sub>	LOW-state output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V	-	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V	-	-	0.1	V
		I <sub>O</sub> = 6.0 mA; V <sub>CC</sub> = 4.5 V	-	-	0.4	V
I <sub>LI</sub>	input leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 6.0 V	-	-	±1.0	μA
		V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>O</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 6.0 V	-	-	±10.0	μA
I <sub>CC</sub>	quiescent supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 6.0 V	-	-	20.0	μA

[1] All typical values are measured at T<sub>amb</sub> = 25 °C.**Table 8: Static characteristics 74HCT2G126**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>T<sub>amb</sub> = -40 °C to +85 °C [1]</b>						
V <sub>IH</sub>	HIGH-state input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	V
V <sub>IL</sub>	LOW-state input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	V
V <sub>OH</sub>	HIGH-state output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	V
		I <sub>O</sub> = -6.0 mA; V <sub>CC</sub> = 4.5 V	3.84	4.32	-	V
V <sub>OL</sub>	LOW-state output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	V
		I <sub>O</sub> = 6.0 mA; V <sub>CC</sub> = 4.5 V	-	0.16	0.33	V
I <sub>LI</sub>	input leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 5.5 V	-	-	±1.0	μA
I <sub>OZ</sub>	3-state output OFF current	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>O</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 5.5 V	-	-	±5.0	μA

**Table 8:** Static characteristics 74HCT2G126 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_{CC}$	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	10.0	$\mu$ A
$\Delta I_{CC}$	additional quiescent supply current	per input; $V_I = V_{CC} - 2.1$ V; $I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V	-	-	375	$\mu$ A
$C_i$	input capacitance		-	1	-	pF
$C_o$	output capacitance		-	1.5	-	pF
<b><math>T_{amb} = -40</math> °C to <math>+125</math> °C</b>						
$V_{IH}$	HIGH-state input voltage	$V_{CC} = 4.5$ V to 5.5 V	2.0	-	-	V
$V_{IL}$	LOW-state input voltage	$V_{CC} = 4.5$ V to 5.5 V	-	-	0.8	V
$V_{OH}$	HIGH-state output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = -20$ $\mu$ A; $V_{CC} = 4.5$ V	4.4	-	-	V
		$I_O = -6.0$ mA; $V_{CC} = 4.5$ V	3.7	-	-	V
$V_{OL}$	LOW-state output voltage	$V_I = V_{IH}$ or $V_{IL}$				V
		$I_O = 20$ $\mu$ A; $V_{CC} = 4.5$ V	-	-	0.1	V
		$I_O = 6.0$ mA; $V_{CC} = 4.5$ V	-	-	0.4	V
$I_{LI}$	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	$\pm 1.0$	$\mu$ A
$I_{OZ}$	3-state output OFF current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_O = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	$\pm 10.0$	$\mu$ A
$I_{CC}$	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	20.0	$\mu$ A
$\Delta I_{CC}$	additional quiescent supply current	per input; $V_I = V_{CC} - 2.1$ V; $I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V	-	-	410	$\mu$ A

[1] All typical values are measured at  $T_{amb} = 25$  °C.

## 11. Dynamic characteristics

**Table 9:** Dynamic characteristics 74HC2G126Voltages are referenced to GND (ground = 0 V);  $C_L = 50$  pF unless otherwise specified; for test circuit see [Figure 7](#).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b><math>T_{amb} = -40</math> °C to <math>+85</math> °C [1]</b>						
$t_{PHL}$ , $t_{PLH}$	propagation delay nA to nY	see <a href="#">Figure 5</a>				
		$V_{CC} = 2.0$ V	-	35	115	ns
		$V_{CC} = 4.5$ V	-	11	23	ns
		$V_{CC} = 5$ V; $C_L = 15$ pF	-	10	-	ns
$t_{PZH}$ , $t_{PZL}$	3-state output enable time nOE to nY	$V_{CC} = 6.0$ V	-	8	20	ns
		see <a href="#">Figure 6</a>				
		$V_{CC} = 2.0$ V	-	40	115	ns
		$V_{CC} = 4.5$ V	-	11	23	ns
		$V_{CC} = 6.0$ V	-	8	20	ns

**Table 9: Dynamic characteristics 74HC2G126 ...continued**

Voltages are referenced to GND (ground = 0 V);  $C_L = 50$  pF unless otherwise specified; for test circuit see [Figure 7](#).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$t_{PHZ}$ , $t_{PLZ}$	3-state output disable time nOE to nY	see <a href="#">Figure 6</a>				
		$V_{CC} = 2.0$ V	-	25	125	ns
		$V_{CC} = 4.5$ V	-	12	25	ns
		$V_{CC} = 6.0$ V	-	10	21	ns
$t_{THL}$ , $t_{TLH}$	output transition time	see <a href="#">Figure 5</a>				
		$V_{CC} = 2.0$ V	-	18	75	ns
		$V_{CC} = 4.5$ V	-	6	15	ns
		$V_{CC} = 6.0$ V	-	5	13	ns
$C_{PD}$	power dissipation capacitance	$V_I = \text{GND to } V_{CC}$	[2]			
		output enabled	-	11	-	pF
		output disabled	-	1	-	pF
<b><math>T_{amb} = -40</math> °C to <math>+125</math> °C</b>						
$t_{PHL}$ , $t_{PLH}$	propagation delay nA to nY	see <a href="#">Figure 5</a>				
		$V_{CC} = 2.0$ V	-	-	135	ns
		$V_{CC} = 4.5$ V	-	-	27	ns
		$V_{CC} = 6.0$ V	-	-	23	ns
$t_{PZH}$ , $t_{PZL}$	3-state output enable time nOE to nY	see <a href="#">Figure 6</a>				
		$V_{CC} = 2.0$ V	-	-	135	ns
		$V_{CC} = 4.5$ V	-	-	27	ns
		$V_{CC} = 6.0$ V	-	-	23	ns
$t_{PHZ}$ , $t_{PLZ}$	3-state output disable time nOE to nY	see <a href="#">Figure 6</a>				
		$V_{CC} = 2.0$ V	-	-	150	ns
		$V_{CC} = 4.5$ V	-	-	30	ns
		$V_{CC} = 6.0$ V	-	-	26	ns
$t_{THL}$ , $t_{TLH}$	output transition time	see <a href="#">Figure 5</a>				
		$V_{CC} = 2.0$ V	-	-	90	ns
		$V_{CC} = 4.5$ V	-	-	18	ns
		$V_{CC} = 6.0$ V	-	-	15	ns

[1] All typical values are measured at  $T_{amb} = 25$  °C.

[2]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:

$f_i$  = input frequency in MHz;

$f_o$  = output frequency in MHz;

$C_L$  = output load capacitance in pF;

$V_{CC}$  = supply voltage in V;

$N$  = number of inputs switching;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.



**Table 10: Dynamic characteristics 74HCT2G126**

Voltages are referenced to GND (ground = 0 V);  $C_L = 50$  pF unless otherwise specified; for test circuit see [Figure 7](#).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b><math>T_{amb} = -40</math> °C to <math>+85</math> °C [1]</b>						
$t_{PHL}$ , $t_{PLH}$	propagation delay nA to nY	see <a href="#">Figure 5</a>				
		$V_{CC} = 4.5$ V	-	15	30	ns
		$V_{CC} = 5$ V; $C_L = 15$ pF	-	12	-	ns
$t_{PZH}$ , $t_{PZL}$	3-state output enable time nOE to nY	$V_{CC} = 4.5$ V; see <a href="#">Figure 6</a>	-	11	31	ns
$t_{PHZ}$ , $t_{PLZ}$	3-state output disable time nOE to nY	$V_{CC} = 4.5$ V; see <a href="#">Figure 6</a>	-	11	35	ns
$t_{THL}$ , $t_{TLH}$	output transition time	$V_{CC} = 4.5$ V; see <a href="#">Figure 5</a>	-	6	15	ns
$C_{PD}$	power dissipation capacitance	$V_I = GND$ to $(V_{CC} - 1.5)$ V	[2]			
		output enabled	-	11	-	pF
		output disabled	-	1	-	pF
<b><math>T_{amb} = -40</math> °C to <math>+125</math> °C</b>						
$t_{PHL}$ , $t_{PLH}$	propagation delay nA to nY	$V_{CC} = 4.5$ V; see <a href="#">Figure 5</a>	-	-	36	ns
$t_{PZH}$ , $t_{PZL}$	3-state output enable time nOE to nY	$V_{CC} = 4.5$ V; see <a href="#">Figure 6</a>	-	-	38	ns
$t_{PHZ}$ , $t_{PLZ}$	3-state output disable time nOE to nY	$V_{CC} = 4.5$ V; see <a href="#">Figure 6</a>	-	-	42	ns
$t_{THL}$ , $t_{TLH}$	output transition time	$V_{CC} = 4.5$ V; see <a href="#">Figure 5</a>	-	-	18	ns

[1] All typical values are measured at  $T_{amb} = 25$  °C.

[2]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:

$f_i$  = input frequency in MHz;

$f_o$  = output frequency in MHz;

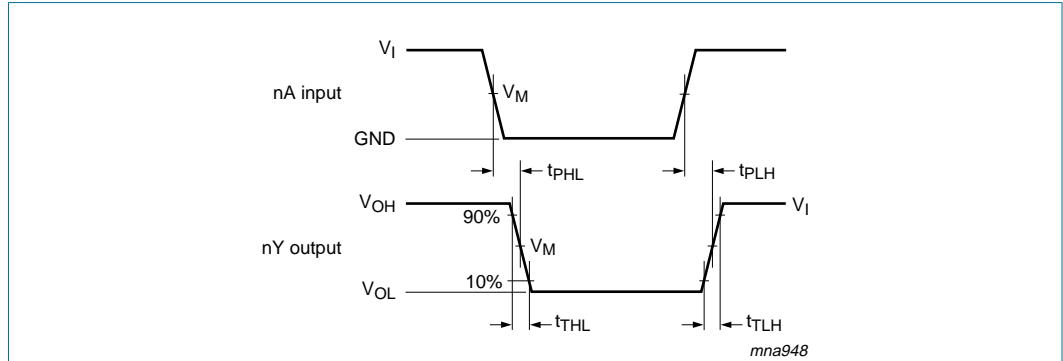
$C_L$  = output load capacitance in pF;

$V_{CC}$  = supply voltage in V;

$N$  = number of inputs switching;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

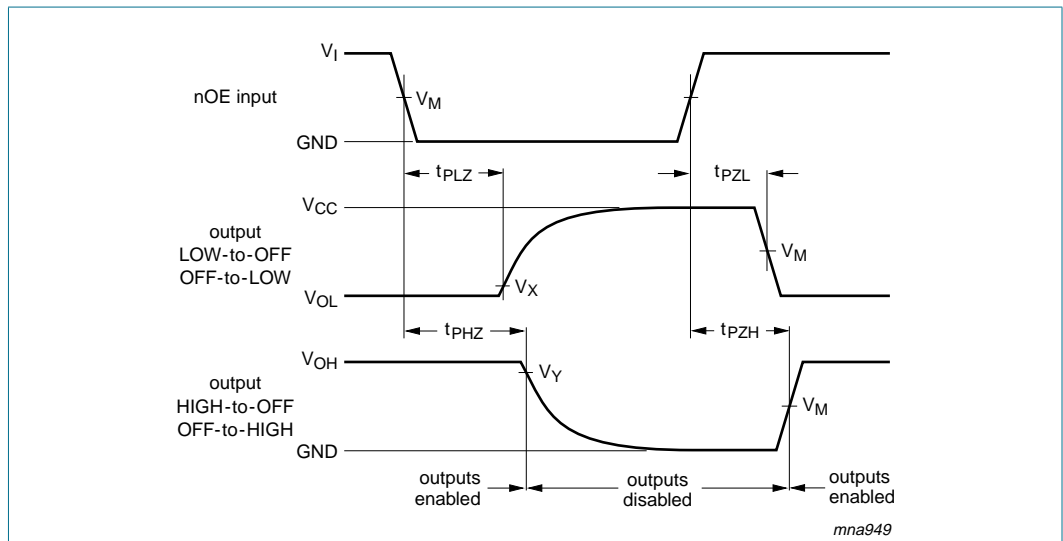
12. Waveforms



Measurement points are given in [Table 11](#).

$V_{OL}$  and  $V_{OH}$  are typical voltage output drop that occur with the output load.

**Fig 5. Propagation delay input (nA) to output (nY) and transition time output (nY)**



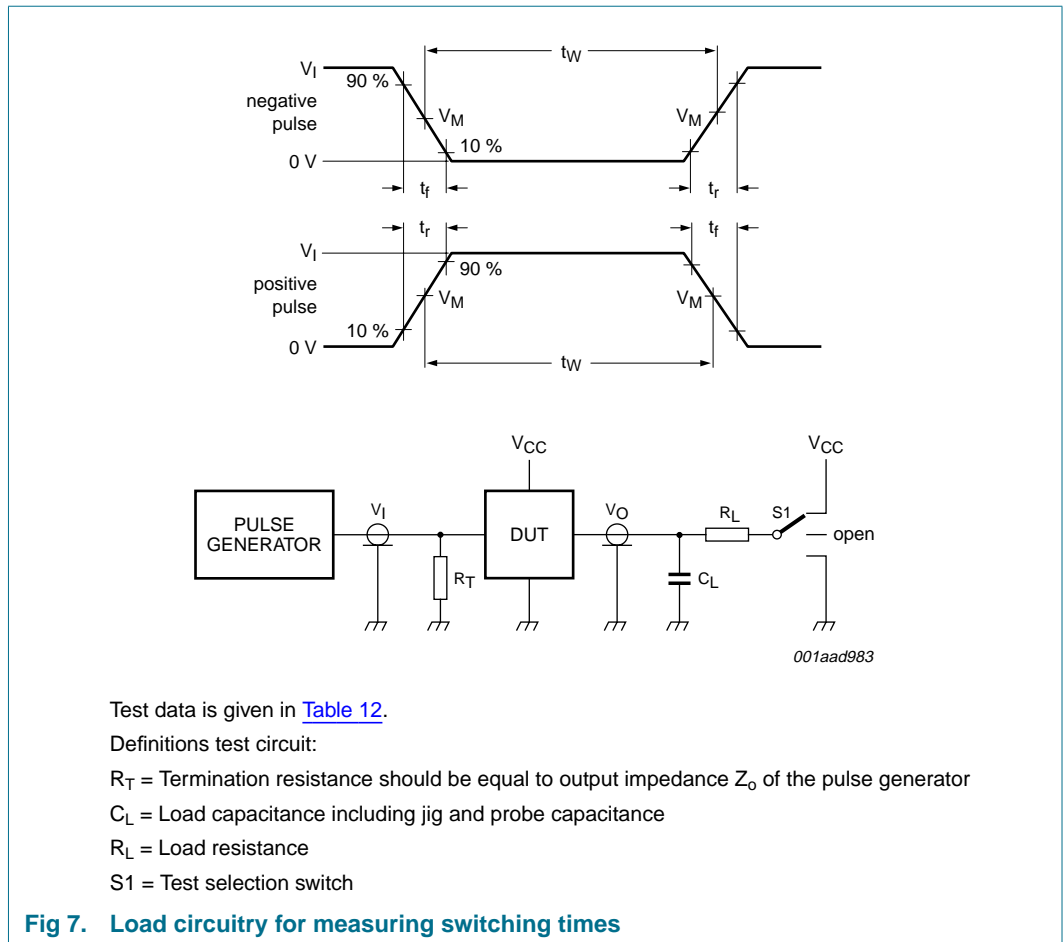
Measurement points are given in [Table 11](#).

$V_{OL}$  and  $V_{OH}$  are typical voltage output drop that occur with the output load.

**Fig 6. 3-state enable and disable times**

**Table 11: Measurement points**

Type	Input	Output
	$V_M$	$V_M$
74HC2G126	$0.5V_{CC}$	$0.5V_{CC}$
74HCT2G126	1.3 V	1.3 V



**Table 12: Test data**

Type	Input		Load		S1 position		
	$V_I$	$t_r, t_f$	$C_L$	$R_L$	$t_{PHL}, t_{PLH}$	$t_{PZH}, t_{PHZ}$	$t_{PZL}, t_{PLZ}$
74HC2G126	$V_{CC}$	6 ns	15 pF, 50 pF	1 k $\Omega$	open	GND	$V_{CC}$
74HCT2G126	3 V	6 ns	15 pF, 50 pF	1 k $\Omega$	open	GND	$V_{CC}$

13. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2

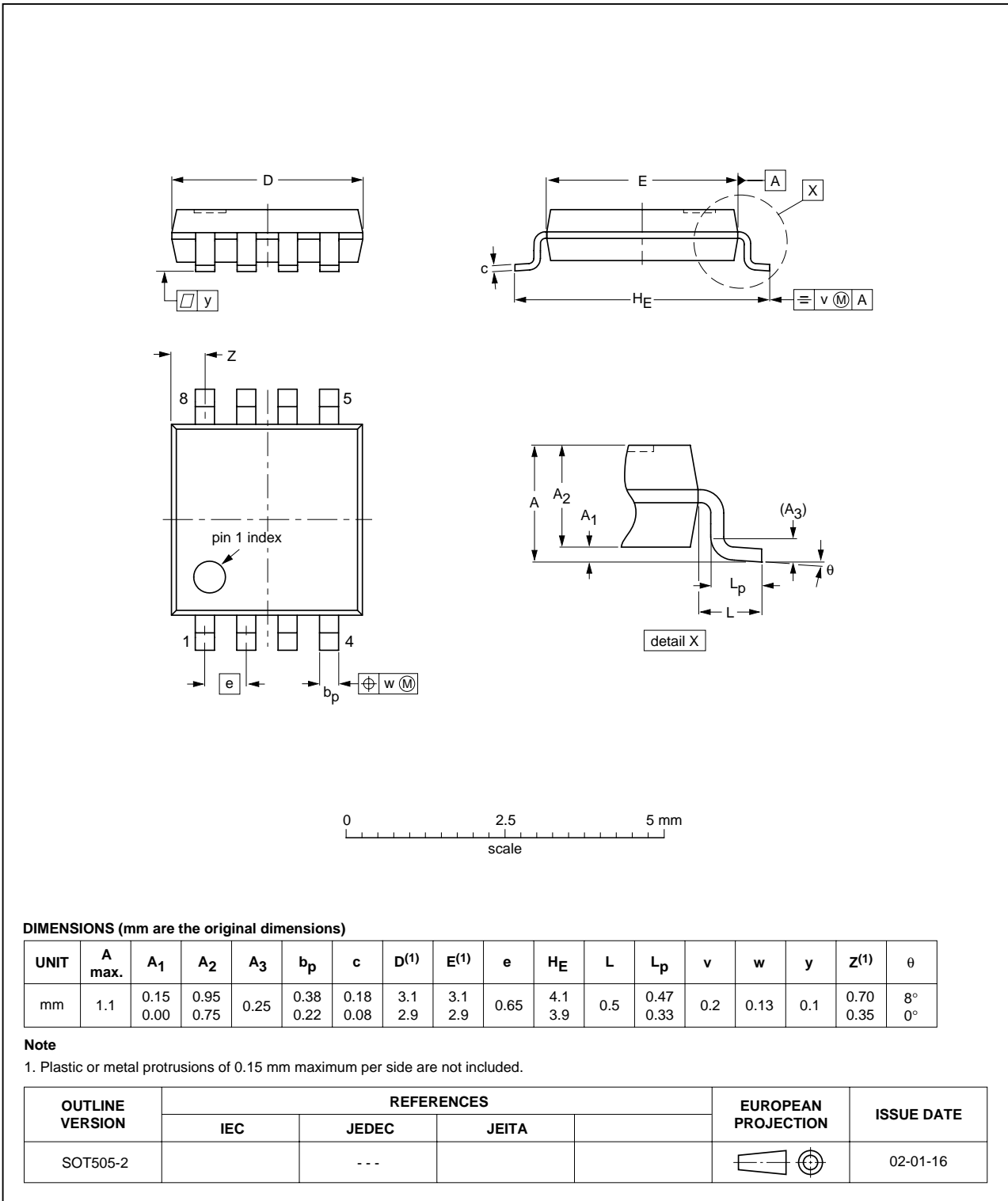


Fig 8. Package outline SOT505-2 (TSSOP8)

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1

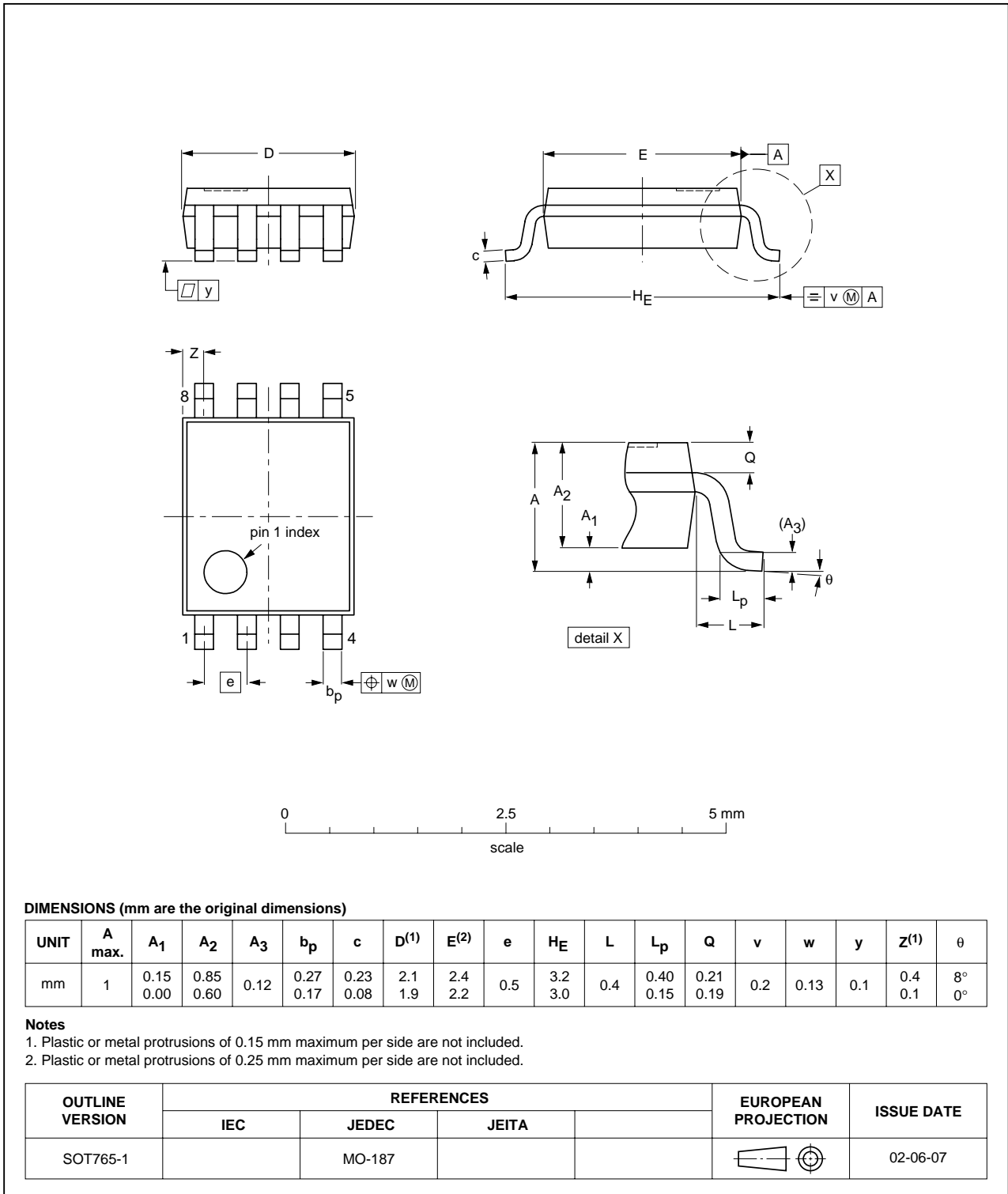


Fig 9. Package outline SOT765-1 (VSSOP8)

## 14. Abbreviations

Table 13: Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

## 15. Revision history

Table 14: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
74HC_HCT2G126_2	20051215	Product data sheet	-	-	74HC_HCT2G126_1
Modifications: <ul style="list-style-type: none"> <li>• The format of this data sheet has been redesigned to comply with the new presentation and information standard of Philips Semiconductors.</li> <li>• <a href="#">Table 7 “Static characteristics 74HC2G126”</a>; section <math>T_{amb} = -40\text{ °C}</math> to <math>+85\text{ °C}</math>:               <ul style="list-style-type: none"> <li>– <math>V_{OH}</math> minimum value at <math>I_O = -6.0\text{ mA}</math> and <math>V_{CC} = 4.5\text{ V}</math>: changed 4.13 to 3.84</li> <li>– <math>V_{OH}</math> minimum value at <math>I_O = -7.8\text{ mA}</math> and <math>V_{CC} = 6.0\text{ V}</math>: changed 5.63 to 5.34</li> </ul> </li> <li>• <a href="#">Table 7 “Static characteristics 74HC2G126”</a>; section <math>T_{amb} = -40\text{ °C}</math> to <math>+125\text{ °C}</math>:               <ul style="list-style-type: none"> <li>– <math>I_{OZ}</math> maximum value changed from <math>10.4\text{ }\mu\text{A}</math> to <math>10.0\text{ }\mu\text{A}</math></li> </ul> </li> <li>• <a href="#">Table 8 “Static characteristics 74HCT2G126”</a>; section <math>T_{amb} = -40\text{ °C}</math> to <math>+85\text{ °C}</math>:               <ul style="list-style-type: none"> <li>– <math>V_{OH}</math> minimum value at <math>I_O = -6.0\text{ mA}</math> and <math>V_{CC} = 4.5\text{ V}</math>: changed 4.13 to 3.84</li> <li>– <math>V_{OL}</math> typical value at <math>I_O = 6.0\text{ mA}</math> and <math>V_{CC} = 4.5\text{ V}</math>: changed 0.15 to 0.16</li> </ul> </li> <li>• <a href="#">Table 8 “Static characteristics 74HCT2G126”</a>; section <math>T_{amb} = -40\text{ °C}</math> to <math>+125\text{ °C}</math>:               <ul style="list-style-type: none"> <li>– <math>I_{OZ}</math> maximum value changed from <math>10.4\text{ }\mu\text{A}</math> to <math>10.0\text{ }\mu\text{A}</math></li> </ul> </li> </ul>					
74HC_HCT2G126_1	20030303	Product data sheet	-	9397 750 10642	-

## 16. Data sheet status

Level	Data sheet status <sup>[1]</sup>	Product status <sup>[2]</sup> <sup>[3]</sup>	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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